



PNP Silicon Low-Power Transistor Qualified per MIL-PRF-19500/485

Qualified Levels: JAN, JANTX, JANTXV and JANS

DESCRIPTION

This family of 2N5415S and 2N5416S epitaxial planar transistors are military qualified up to a JANS level for high-reliability applications. These devices are also available in the longer leaded TO-5 and low profile U4 and UA packaging.

Important: For the latest information, visit our website http://www.microsemi.com.

FEATURES

- JEDEC registered 2N5415 through 2N5416 series
- JAN, JANTX, JANTXV, and JANS qualifications are available per MIL-PRF-19500/485. (See part nomenclature for all available options.)
- RoHS compliant commercial version

APPLICATIONS / BENEFITS

- General purpose transistors for low power applications requiring high frequency switching.
- Low package profile.
- Military and other high-reliability applications.



TO-205AD (TO-39) Package

Also available in:

TO-5 package (long-leaded) 2N5415 - 2N5416

U4 package (surface mount) 📆 2N5415U4 – 2N5416U4

UA package (surface mount) **1 2N5415UA – 2N5416UA**

MAXIMUM RATINGS @ T_A = +25 °C unless otherwise noted

| Parameters / Test Conditions | | 2N5415S | 2N5416S | Unit |
|---|-----------------|------------|---------|------|
| Collector-Emitter Voltage | V_{CEO} | 200 300 | | V |
| Collector-Base Voltage | V_{CBO} | 200 350 | | V |
| Emitter-Base Voltage | V_{EBO} | 6.0 6.0 | | V |
| Collector Current | Ic | 1.0 1.0 | | Α |
| Operating & Storage Junction Temperature Range | T_J,T_stg | -65 to | °C | |
| Thermal Resistance Junction-to-Ambient | $R_{\Theta JA}$ | 234 | | °C/W |
| Thermal Resistance Junction-to-Case | $R_{	heta JC}$ | 17.5 | | °C/W |
| Total Power Dissipation @ $T_A = +25$ °C $^{(1)}$ @ $T_C = +25$ °C $^{(2)}$ | P _T | 0.75 10 | | W |

Notes: 1. Derate linearly 4.29 mW/°C for TA > +25 °C.

2. Derate linearly 57.2 mW/°C for $T_C > +25$ °C.

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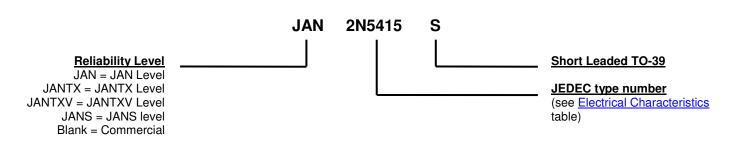
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MECHANICAL and PACKAGING

- CASE: Hermetically sealed, kovar base, nickel cap
- TERMINALS: Gold plated kovar and solder dip (Sn63/Pb37) on JAN, JANTX, and JANTXV versions. NOTE: Solder dipped versions are not RoHS compliant.
- MARKING: Part number, date code, manufacturer's ID and serial number
- POLARITY: PNP
- WEIGHT: Approximately 1.064 grams
- See Package Dimensions on last page.

PART NOMENCLATURE



| SYMBOLS & DEFINITIONS | | | | |
|-----------------------|--|--|--|--|
| Symbol | Definition | | | |
| C_obo | Common-base open-circuit output capacitance | | | |
| I _{CEO} | Collector cutoff current, base open | | | |
| I _{CEX} | Collector cutoff current, circuit between base and emitter | | | |
| I _{EBO} | Emitter cutoff current, collector open | | | |
| h_{FE} | Common-emitter static forward current transfer ratio | | | |
| $V_{\sf CEO}$ | Collector-emitter voltage, base open | | | |
| V_{CBO} | Collector-emitter voltage, emitter open | | | |
| V_{EBO} | Emitter-base voltage, collector open | | | |



ELECTRICAL CHARACTERISTICS @ T_A = +25 °C, unless otherwise noted

OFF CHARACTERISTICS

| Parameters / Test Conditions | | Symbol | Min. | Max. | Unit |
|--|---------|-------------------|------|------|------|
| Collector-Emitter Breakdown Voltage | | | | | |
| $I_{\rm C} = 50 \text{mA}, I_{\rm B} = 5 \text{mA},$ | 2N5415S | $V_{(BR)CEO}$ | 200 | | V |
| L = 25 mH; $f = 30 - 60 Hz$ | 2N5416S | | 300 | | |
| Emitter-Base Cutoff Current | | | | 20 | |
| $V_{EB} = 6.0 \text{ V}$ | | I _{EBO} | | 20 | μΑ |
| Collector-Emitter Cutoff Current | | | | | |
| $V_{CE} = 200 \text{ V}, V_{BE} = 1.5 \text{ V}$ | 2N5415S | I _{CEX} | | 50 | μΑ |
| $V_{CE} = 300 \text{ V}, V_{BE} = 1.5 \text{ V}$ | 2N5416S | | | | |
| Collector-Emitter Cutoff Current | | | | | |
| $V_{CE} = 150 \text{ V}$ | 2N5415S | I _{CEO1} | | 50 | μΑ |
| $V_{CE} = 250 \text{ V}$ | 2N5416S | | | | |
| Collector-Emitter Cutoff Current | | | | | |
| $V_{CE} = 200 \text{ V}$ | 2N5415S | I _{CEO2} | | 1 | mA |
| $V_{CE} = 300 \text{ V}$ | 2N5416S | | | | |
| Collector-Base Cutoff Current | | | | | |
| $V_{CB} = 175 \text{ V}$ | 2N5415S | I _{CBO1} | | 50 | μΑ |
| $V_{CB} = 280 \text{ V}$ | 2N5416S | [| | | |
| $V_{CB} = 200 \text{ V}$ | 2N5415S | 1 | | 500 | |
| $V_{CB} = 350 \text{ V}$ | 2N5416S | I _{CBO2} | | 300 | μΑ |
| $V_{CB} = 175 \text{ V}, T_A = +150 {}^{\circ}\text{C}$ | 2N5415S | Lanca | | 1 | mA |
| $V_{CB} = 280 \text{ V}, T_A = +150 {}^{\circ}\text{C}$ | 2N5416S | I _{CBO3} | | l l | шА |

ON CHARACTERISTICS

| Parameters / Test Conditions | Symbol | Min. | Max. | Unit |
|---|----------------------|----------------|------|------|
| Forward-Current Transfer Ratio $I_C = 50$ mA, $V_{CE} = 10$ V $I_C = 1$ mA, $V_{CE} = 10$ V $I_C = 50$ mA, $V_{CE} = 10$ V, $T_A = +150$ $^{\circ}$ C | h _{FE} | 30 15 15 | 120 | |
| Collector-Emitter Saturation Voltage I _C = 50 mA, I _B = 5 mA | V _{CE(sat)} | | 2.0 | V |
| Base-Emitter Voltage Non-Saturation $I_C = 50 \text{ mA}, V_{CE} = 10 \text{ V}$ | V_{BE} | | 1.5 | V |

DYNAMIC CHARACTERISTICS

| Parameters / Test Conditions | Symbol | Min. | Max. | Unit |
|---|------------------|------|------|------|
| Magnitude of Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio $I_C = 10 \text{ mA}, V_{CE} = 10 \text{ V}, f = 5 \text{ MHz}$ | h _{fe} | 3 | 15 | |
| Small-signal short Circuit Forward-Current Transfer Ratio $I_C = 5 \text{ mA}, V_{CE} = 10 \text{ V}, f \le 1 \text{ kHz}$ | h _{fe} | 25 | | |
| Output Capacitance $V_{CB} = 10 \text{ V}, I_E = 0, 100 \text{ kHz} \le f \le 1 \text{ MHz}$ | C _{obo} | | 15 | pF |



ELECTRICAL CHARACTERISTICS @ T_A = +25 °C unless otherwise noted. (continued)

SWITCHING CHARACTERISTICS

| Parameters / Test Conditions | Symbol | Min. | Max. | Unit |
|---|------------------|------|------|------|
| Turn-On Time $V_{CC} = 200 \text{ V}, I_C = 50 \text{ mA}, I_{B1} = 5 \text{ mA}$ | t _{on} | | 1 | μs |
| Turn-Off Time $V_{CC} = 200 \text{ V}, I_C = 50 \text{ mA}, I_{B1} = I_{B2} = 5 \text{ mA}$ | t _{off} | | 10 | μs |

SAFE OPERATING AREA (See SOA graph below and MIL-STD-750, method 3053)

DC Tests

 $T_C = +25$ °C, $t_P = 0.4$ s, 1 Cycle

Test 1

 V_{CE} = 10 V, I_{C} = 1 A

Test 2

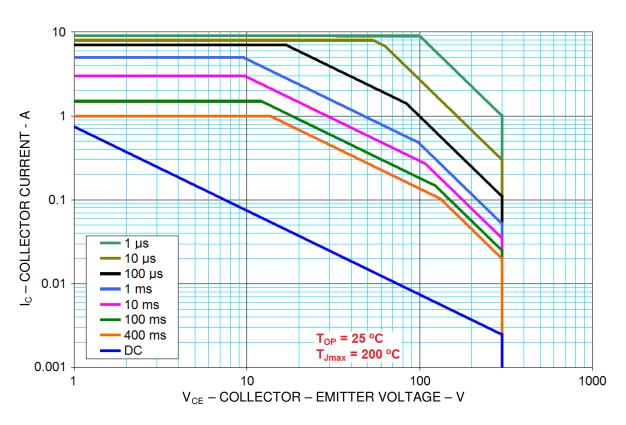
 $V_{CE} = 100 \text{ V}, I_{C} = 100 \text{ mA}$

Test 3

 $V_{CE} = 200 \text{ V}, I_{C} = 24 \text{ mA } (2N5415S \text{ only})$

Test 4

 $V_{CE} = 300 \text{ V}, I_{C} = 10 \text{ mA} (2N5416S \text{ only})$



Maximum Safe Operating Area (T_J = 200 °C)



GRAPHS

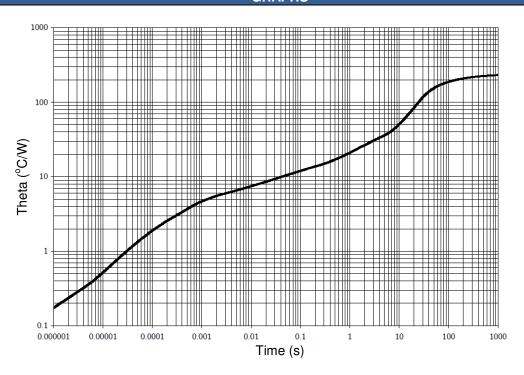


FIGURE 1
Thermal impedance graph (R_{OJA})

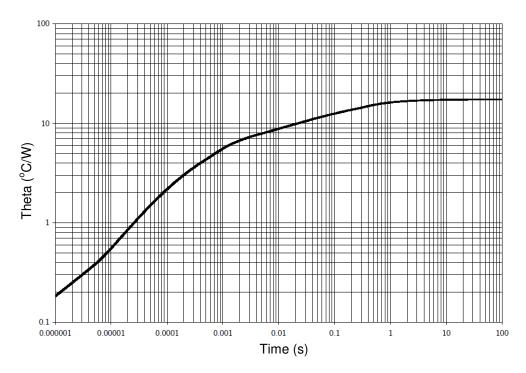
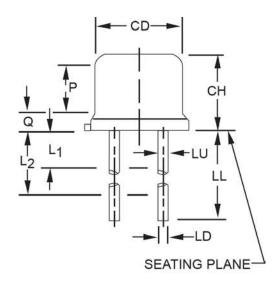


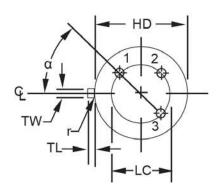
FIGURE 2
Thermal impedance graph (R_{OJA})

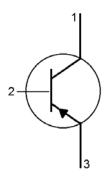


PACKAGE DIMENSIONS



| | Dimensions | | | | |
|----------------|------------|----------|--------|-------------|------|
| Symbol | In | Inch | | Millimeters | |
| | Min | Max | Min | Max | |
| CD | 0.305 | 0.335 | 7.75 | 8.51 | |
| CH | 0.240 | 0.260 | 6.10 | 6.60 | |
| HD | 0.335 | 0.370 | 8.51 | 9.40 | |
| LC | 0.20 | 0.200 TP | | 3 TP | 6 |
| LD | 0.016 | 0.021 | 0.41 | 0.53 | 7, 8 |
| LL | 0.500 | 0.750 | 12.70 | 19.05 | 7, 8 |
| LU | 0.016 | 0.019 | 0.41 | 0.48 | 7, 8 |
| L ₁ | - | 0.050 | - | 1.27 | 7, 8 |
| L ₂ | 0.250 | - | 6.35 | - | 7, 8 |
| Q | - | 0.050 | - | 1.27 | 5 |
| TL | 0.029 | 0.045 | 0.74 | 1.14 | 4 |
| TW | 0.028 | 0.034 | 0.71 | 0.86 | 3 |
| r | - | 0.010 | - | 0.25 | 10 |
| α | 45° | TP | 45° TP | | 6 |
| Р | 0.100 | - | 2.54 | - | |





NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for information only.
- 3. Beyond r (radius) maximum, TW shall be held for a minimum length of 0.011 (0.28 mm).
- 4. Dimension TL measured from maximum HD.
- 5. Body contour optional within zone defined by HD, CD, and Q.
- Leads at gauge plane 0.054 +0.001 -0.000 inch (1.37 +0.03 -0.00 mm) below seating plane shall be within 0.007 inch (0.18 mm) radius of true position (TP) at maximum material condition (MMC) relative to tab at MMC. This device may be measured by direct methods.
- 7. Dimension LU applies between L1 and L2. Dimension LD applies between L2 and minimum. Diameter is uncontrolled in L1 and beyond LL minimum.
- 8. All three leads.
- 9. The collector shall be internally connected to the case.
- 10. Dimension r (radius) applies to both inside corners of tab.
- 11. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.
- 12. Lead 1 = emitter, lead 2 = base, lead 3 = collector.